

# MAINTENANCE MANUAL ORION™ (Dual Bandwidth)

## UHF POWER AMPLIFIER UNITS

344A4573P1	20 WATT	403-440 MHz
344A4573P2	20 WATT	440-470 MHz
344A4573P3	40 WATT	403-440 MHz
344A4573P4	40 WATT	440-470 MHz
344A4573P5	35 WATT	470-512 MHz
344A4573P6	100 WATT	403-440 MHz
344A4573P7	100 WATT	440-470 MHz
344A4573P8	80 WATT	470-512 MHz

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## DESCRIPTION

The **Radio Frequency (RF) Power Amplifiers** for the UHF **ORION™** mobile radio are provided in three different frequency ranges and power levels designated as follows:

- 344A4573P1 (CAH-545EA) - 403-440 MHz, 20 WATT used in low power applications  
344A4573P2 (CAH-545EB) - 440-470 MHz, 20 WATT used in low power applications
- 344A4573P3 (CAH-545AL) - 403-440 MHz, 40 WATT used in mid power applications  
344A4573P4 (CAH-545BL) - 440-470 MHz, 40 WATT used in mid power applications  
344A4573P5 (CAH-545CL) - 470-512 MHz, 35 WATT used in mid power applications
- 344A4573P6 (CAH-545AH) - 403-440 MHz, 100 WATT used in high power applications  
344A4573P7 (CAH-545BH) - 440-470 MHz, 100 WATT used in high power applications  
344A4573P8 (CAH-545CH) - 470-512 MHz, 80 WATT used in high power applications

The exciter for each of the three power amplifiers is located on Synthesizer/Receiver/Exciter board CMN-354-1. This exciter circuit provides approximately 500 milliwatt input to the PA (refer to Maintenance Manual LBI- 39163). The PA utilizes a single power amplifier module (HC1) as the driver unit. In the case of the 20 watt amplifier the power module is the only power amplifying unit (Refer to Figure 1). With the other two power levels the power module drives other power transistors to provide the power output required (Refer to Figures 2 and 3). Each power amplifier is provided with an antenna switch and limiter circuit to isolate the receive circuit from the transmit circuit, limiting the receiver input from being over driven due to large RF signals. Each power amplifier has a power detect circuit which controls an **Automatic Power Control (APC)** circuit to keep the power output constant. A low-pass filter is provided in the antenna circuit to reduce harmonic emissions. A keyed **Tx 9V** regulator is provided to power the APC circuits.

## CIRCUIT ANALYSIS

### 20 WATT

The 20 Watt PA assembly uses one power module (HC1) to provide the output power.

Supply voltage for the power amplifier is connected from power leads on the System Interface Board to J3 (A+) and G (A-) on the PA Board. Diode CD7 is a surge protector to suppress pulses on the power leads. Diode CD8 will cause the fuse to blow if the polarity of the power leads is reversed.

The Exciter output is coupled through connector J151 on the Synthesizer/Receiver/Exciter Board to input connector J1 on the PA board. The 500 milliwatt RF input at J1 is coupled to power module HC1 through an attenuator pad consisting of resistors R1-R3. This pad attenuates the power to about 300 milliwatt and provides isolation between Exciter and PA. The power module (HC1) amplifies the 300 milliwatt input to 20 Watts.

The power module consists of a three-stage RF amplifier (Refer to **IC DATA**). The first stage power supply voltage is supplied by the power control circuit. The second and third stage power supply voltage is supplied by **SMOOTHING FILTER** transistor TR1. The second and third stage RF amplifiers operate as class C.

The 20 Watts output of HC1 is coupled to the **ANTENNA** and **ANTENNA SWITCH & LIMITER** circuits through 50 ohm stripline Z1.

### Antenna Switch & Limiter

The Antenna Switch circuit consists of capacitor C25 and inductor L9 and takes the place of a quarter-wave micro strip line. When **TX9V** output goes high, bias current flows through switching diodes CD3 and CD4. A low impedance now exists at the anode of CD4 and a high impedance exists at the node connection of C25 and L9. This isolates the transmitter power from the receiver. Diode CD3 is now an RF short and along with capacitor C12, couples the power to the lowpass filter and on to the antenna.

The limiter circuit consists of transistors TR7, TR8 and diode package CD13. While receiving, if the received signal level exceeds +10 dBm, the rectified currents of CD13 provide forward bias to TR7, TR8 and PIN diode CD4 proportional to the received signal level. This causes a quarter-wave circuit (lumped constants C25 and L9) to turn on when the received signal exceeds +10 dBm and protects the receiver from excessively high receive signal levels.

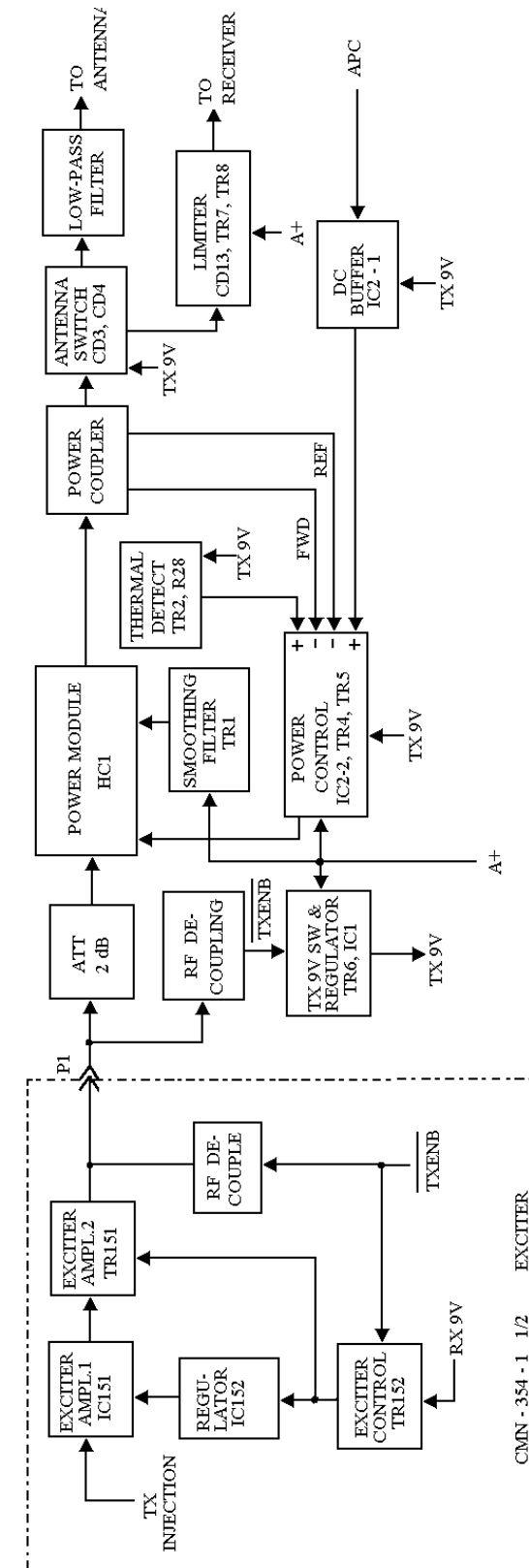


Figure 1 - 20-Watt Power Amplifier Block Diagram

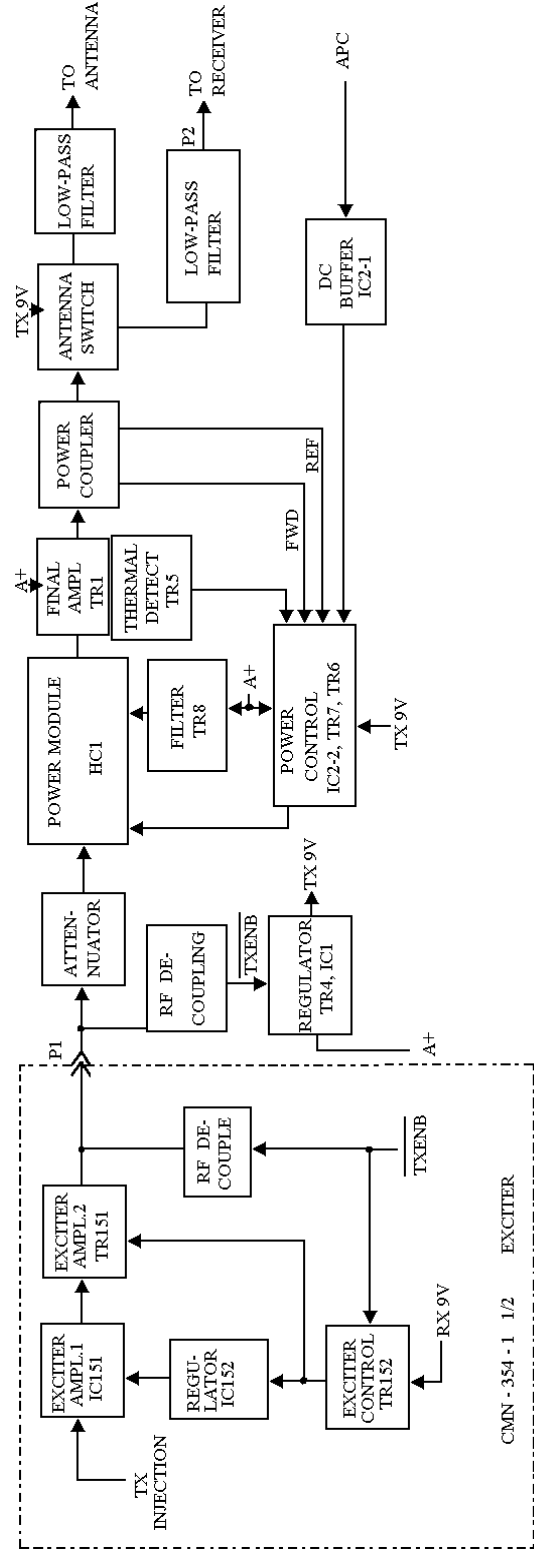


Figure 2 - 35/40-Watt Power Amplifier Block Diagram

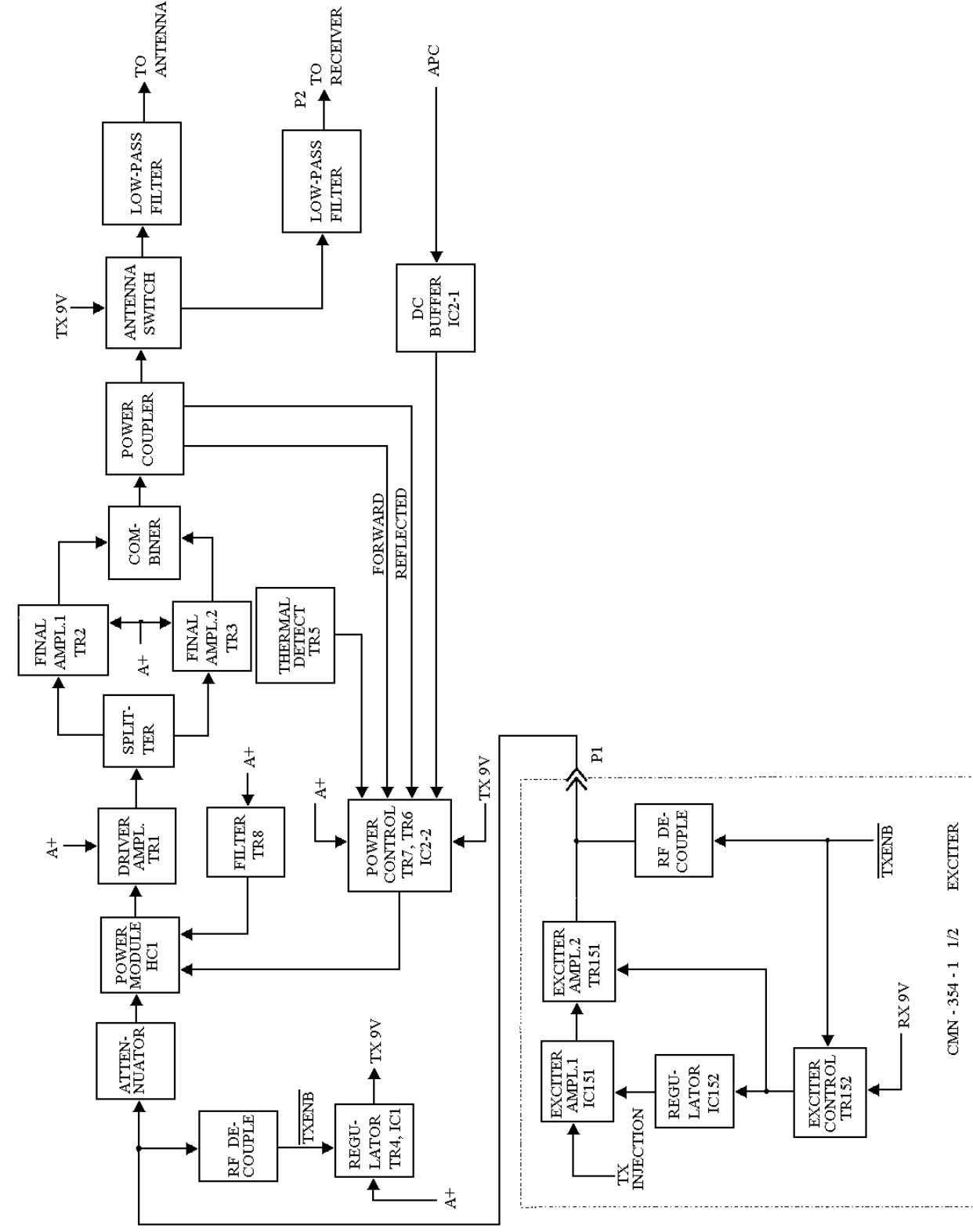


Figure 3 - 80/100 - Watt Power Amplifier Block Diagram

## Tx 9V Switch

When the lead, located on the Synthesizer/Receiver/Exciter board, goes low, the DC voltage on J151 goes low. On the PA board, the DC voltage on J1 also goes low completing the circuit for diode CD9. With CD9 conducting TX 9V Switch transistor TR6 conducts applying A+ (13.32 V) to the input of +9 Volt Regulator IC1. The regulated +9 volts applies bias to operational amplifier IC2, transistor TR2 and switching diodes CD3 and CD4.

## Power Control

The **Auto Power Control (APC)** circuit protects the transmitter PA from damage due to:

- excessive output power
- excessive reflected power
- excessive temperature

The output power control circuit allows the RF output power to be set at rated power by the APC voltage from the Logic/IF/Audio Board. If the output power of the PA increases, the detected voltage and the input to operational amplifier IC2-2 increases. The output voltage of operational amplifier IC2-2 decreases. This causes **DC DRIVER** transistor TR5 to conduct less. This increases the base voltage on PNP **DC PASS** transistor TR4, causing it to conduct less. This results in less voltage being applied to the first amplifier stage in RF Power Module HC1, reducing the output power of the PA in proportion to the increases in output power detected by the circuit.

To protect the PA against badly mismatched loads, a reverse power detector circuit (**VSWR**) consisting of diode CD2, transistor TR5, operational amplifier IC2-2 and pass transistor TR4 detects reverse (reflected) power. When sufficient power is detected by CD2 to cause it to conduct, the voltage at the output of IC2-2 decreases, causing the Power Module to lower the output power, protecting the PA. The reverse power level is set by resistor R8 connected in series with diode CD2.

The PA is protected against temperature increases by a thermal detector circuit. This circuit consists of resistor R28, **THERMAL DETECT** transistor TR2, **DC DRIVER** transistor TR5 and **DC AMPL** operational amplifier IC2-2. As temperature increases, the resistance to ground through thermal detector resistor R28 increases. This causes IC2-2 to conduct less, causing a decrease in PA output until the temperature level is reduced. The temperature level is set by resistor R28. When the heatsink temperature rises above 90 C, the resistance of R28 increases and the power output is reduced.

## 35/40 WATT

The 35/40 Watt PA assembly uses one power module (HC1) and one RF power transistor (TR1) to provide the output power.

Supply voltage for the power amplifier is connected from power leads on the System Interface Board to J3 (A+) and G (A-) on the PA Board. Diode CD2 is a surge protector to suppress pulses on the power leads. (Diode CD1001 in the PA UNIT will cause a fuse to blow if the voltage polarity is reversed. Refer to the PA INTERCONNECTION DIAGRAM)

**Test Points (TP)** are the printed board terminals for measuring control voltage as follows:

- TP1 A+ (13.42V)
- TP2 Control Voltage (4.72V)
- TP3 Forward Power Detect (2.64V)
- TP4 Tx 9V (9.12V)
- TP5 APC Voltage on output of DC AMPL IC2-1 (2.64V)
- TP6 Voltage to HC1, pins 3 & 4 (12.5V)
- TP7 APC Voltage (3.5V)

The Exciter output is coupled through connector J151 on the Synthesizer/Receiver/Exciter Board to input Jack P1 on the PA board. The 500 milliwatt RF input at P1 is coupled to power module HC1 through an attenuator pad consisting of resistors R1-R4. This pad attenuates the 500 milliwatt to about 300 milliwatt and provides isolation between Exciter and PA. The power module (HC1) amplifies the 300 milliwatt input to 13 Watts.

The power module consists of a three-stage RF amplifier (Refer to IC DATA). The first stage power supply voltage is supplied by the power control circuit. The second and third stage power supply voltage is supplied by **SMOOTHING FILTER** transistor TR8. The second and third RF amplifiers operate as class C.

The 13 Watts output of HC1 is coupled to **POWER AMPL** transistor TR1 through impedance matching components consisting of capacitors C7, C9, C10 and inductor L2 through coupling capacitor C8. Transistor TR1 amplifies the 13 Watt level to 40 Watts. The output of TR1 is coupled to the **ANTENNA** and **ANTENNA SWITCH** through impedance matching components consisting of capacitors C11-C13, inductor L6 and impedance matching network Z2 through coupling capacitor C14 and 50 ohm stripline Z7.

## Antenna Switch

The Antenna Switch circuit consists of capacitor C64 and inductor L23 and takes the place of a quarter-wave micro strip line. When **TX9V** output goes high, bias current flows through switching diodes CD5, CD7 and CD9. A low impedance now exists at the anode of CD7 and a high impedance exists at the connection of C64 and L23. This isolates the transmitter power from the receiver. Diode CD5 is now an RF short and along with capacitor C55 couples the power to the lowpass filter and on to the antenna.

## Tx 9V Switch

When the **TX ENB** lead goes low, TX 9V switch transistor TR4 conducts applying A+ (13.32 V) to the input of +9 Volt Regulator IC1. The regulated +9 volts (**TX 9V**) applies bias to operational amplifier IC2, transistor TR5 and switching diodes CD5, CD7 and CD9.

## Power Control

The **Auto Power Control (APC)** circuit protects the transmitter PA from damage due to:

- excessive output power
- excessive reflected power
- excessive temperature

The output power control circuit allows the RF output power to be set at rated power by the APC voltage from the Logic/IF/Audio Board. If the output power of the PA increases, the detected voltage and the input of operational amplifier IC2-2 increases. The output voltage of IC2-2 decreases. This causes **DC DRIVER** transistor TR6 to conduct less. This increases the base voltage on PNP **DC PASS** transistor TR7, causing it to conduct less. This results in less voltage being applied to the first amplifier stage in driver module (HC1), reducing the output power of the PA in proportion to the increases in output power detected by the circuit.

To protect the PA against badly mismatched loads, a reverse power detector circuit (**VSWR**) consisting of diode CD4, transistor TR6, operational amplifier IC2-2 and pass transistor TR7 detects reverse (reflected) power. When sufficient power is detected by CD4 to cause it to conduct, the voltage at the output of IC2-2 decreases, causing the driver module to lower the output power, protecting the PA. The reverse power level is set by resistor R15 connected in series with diode CD4.

The PA is protected against temperature increases by a thermal detector circuit. This circuit consists of resistor R49, transistors TR5, TR6, TR7 and operational amplifier IC2-2. As temperature increases, the resistance to ground through thermal detector resistor R49 increases. This causes IC2-2 to conduct less, causing a decrease in PA output until the temperature level is reduced. The temperature level is set by resistor R49. When the heatsink temperature rises above 90 C, the resistance of R49 increases and the power output is reduced.

## 80/100 WATT

The 80/100 Watt PA assembly uses one power module (HC1) and three RF power transistors (TR1, TR2 and TR3) to provide the output power.

Supply voltage for the power amplifier is connected from power leads on the System Interface Board to J3 (A+) and G (A-) on the PA Board. Capacitors C73 and C95 prevent RF from getting on the power leads. Diode CD1 causes a fuse to blow if the polarity of the power leads is reversed. Diode CD2 is a surge protector to suppress pulses on the power leads.

**Test Points (TP)** are the printed board terminals for measuring control voltage as follows:

- TP1 A+ (13.32V)
- TP2 Control Voltage (4.27V)
- TP3 Forward Power Detect (3.2V)
- TP4 Tx 9V (9.2V)
- TP5 APC Voltage on output of DC AMPL IC2-1 (2.66V)
- TP6 Voltage to HC1, pins 3 & 4 (12.8V)
- TP7 APC Voltage (3.5V)

The exciter output is coupled through connector J102 on the Synthesizer/Receiver/Exciter Board to input Jack P1 on the PA board. The 500 milliwatt RF input at P1 is coupled to power module HC1 through an attenuator pad consisting of resistors R1 through R4. This pad attenuates the 500 milliwatt input to 300 milliwatt and provides isolation between the Exciter and PA. **POWER MODULE** HC1 amplifies the 300 milliwatt input to 12 Watts. The power module (HC1) consists of a three stage RF amplifier. The first stage of the module is controlled by the voltage from the power control circuit. The amplifier consist of a Class C driver amplifier and two Class C common-emitter amplifiers. The 12 watt output is coupled to **DRIVER AMPL** transistor TR1 through impedance matching components consisting of capacitors C7, C9 C10, inductors L2 through L4 and coupling

capacitor C8. The output of TR1 is coupled to the power **SPLITTER** through the impedance matching components consisting of capacitors C11 through C13, C15, C96, C97, inductor L6 and impedance matching network Z1 through coupling capacitor C14. Transistor TR1 amplifies the 12 watt input level to 40 watts. The power splitter consists of capacitors C18, C27, C36 and Inductors L7 and L11. Resistor R5 absorbs any unbalance in the drive to **POWER AMPL-1**, **AMPL-2** transistors TR2 and TR3. These power amplifier stages consist of two identical paralleled Class C power amplifiers. The output of the power splitter is coupled to transistors TR2 and TR3 through coupling capacitors C19 and C28 and the impedance matching components consisting of capacitors C20, C21, C29 and C30. The output of TR2 and TR3 is coupled to the power combiner through impedance matching components consisting of capacitors C22-C25, C31-C34 and impedance matching networks Z2 and Z3. The power **COMBINER** consists of capacitors C26, C35, C40, C41 and inductors L10, L14 and L15. Resistor R8 absorbs the difference in the output power of TR2 and TR3. Transistors TR2 and TR3 each amplify the input level from 20 watts to about one-half (1/2) of the rated output power. The output of the combiner is coupled to the **ANTENNA SWITCH** through 50 ohm stripline Z7.

### Antenna Switch

The antenna switch circuit consists of capacitor C64 and inductor L23 and takes the place of a quarter-wave micro strip line. When **TX9V** output goes high, bias current flows through switching diodes CD6 through CD9. A low impedance now exists at the anode of CD7 and CD8 and high impedance exists at the connection of C64 and L23. This isolates the transmitter power from the receiver. Diode CD6 is now an RF short and along with capacitor C55 couples the power to the lowpass filter and on to the antenna.

### Tx 9V Switch

When the **TX ENB** lead goes low, **TX 9V** switch transistor TR4 conducts applying A+ (13.32 V) to the input of +9 Volt Regulator IC1. The regulated +9 volts (**TX 9V**) applies bias to operational amplifier IC2, transistor TR5 and switching diodes CD6 through CD9.

### Power Control

The Automatic Power Control (APC) circuit protects the transmitter PA from damage due to:

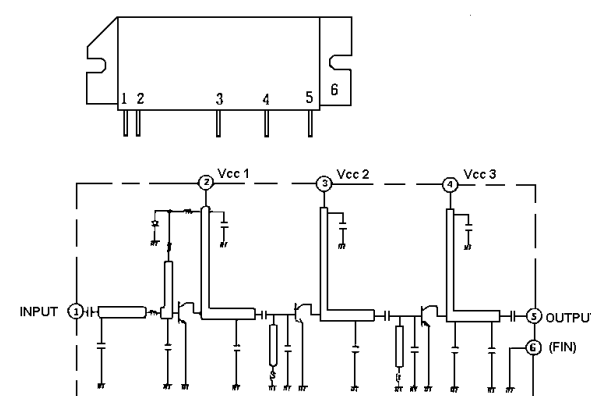
- excessive output power
- excessive reflected power
- excessive temperature

The output power control circuit allows the RF output power to be set at rated power by the APC voltage from the LOGIC/IF/AUDIO Board. If the output power of the PA increases, the detected voltage and the input of operational amplifier IC2-2 increases. The output voltage of operational amplifier IC2-2 decreases. This causes transistor TR6 to conduct less. This increases the base voltage on PNP pass transistor TR7, causing it to conduct less. This results in less voltage being applied to the first amplifier stage in driver module (HC1), reducing the output power of the exciter/ PA in proportion to the increases in output power detected by the circuit.

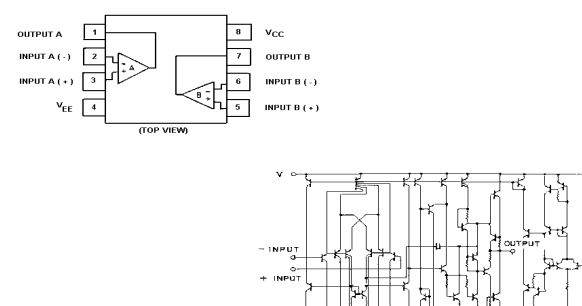
To protect the PA against badly mismatched loads, a reverse power detector circuit (VSWR) consisting of diode CD4, transistor TR6, operational amplifier IC2-2 and pass transistor TR7 detect reverse (reflected) power. When sufficient power is detected by CD4 to cause it to conduct, the voltage at the output of IC2-2 decreases, causing the driver module to lower the output power, protecting the PA. The reverse power level is set by resistor R15 connected in series with diode CD4.

The PA is protected against temperature increases by a thermal detector circuit. This circuit consists of resistor R49, transistors TR5, TR6, TR7 and operational amplifier IC2-2. As temperature increases, the resistance to ground through thermal detector resistor R49 increases. This causes IC2-2 to conduct less, causing a decrease in PA output until the temperature level is reduced. The temperature level is set by resistor R49. When the heatsink temperature rises above 90 C, the resistance of R49 increases and the power output is reduced.

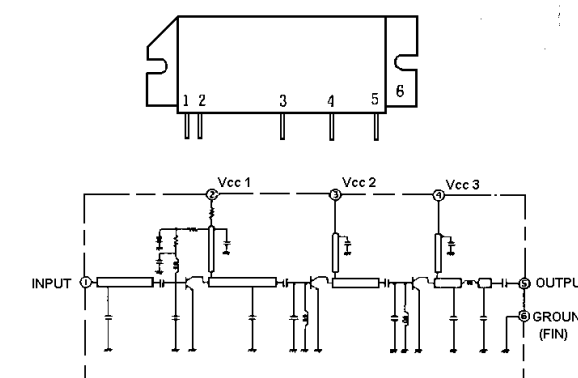
### 403-512 MHz, 20-WATT POWER MODULE HC1



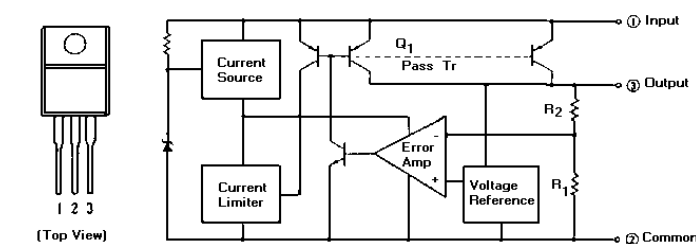
### OPERATIONAL AMPLIFIER IC2



### 403-512 MHz, 35/40 -WATT POWER MODULE HC1



### 9 VOLT REGULATOR IC1



**PA UNIT (EUROPEAN MODEL)**  
**344A4573P1/JHM-471EA, 344A4573P2/JHM-471PEB**

SYMBOL	PART NO.	DESCRIPTION
A1001 A1001 A1002 C1001 and C1002 J1001 TB1001	Note: Parts listed are for reference only. Refer to Service Section for serviceable parts.	PA CIRCUIT CAH-545EA (Used in P1) PA CIRCUIT CAH-545EB (Used in P2) INTERFACE CMH-1231E -----CAPACITORS----- Ceramic: 1000 pF +50%, -20% 50 VDCW temp coef ±15%.  H-6JALD00005 ALB-01A ----- COAXIAL CABLES ----- 250V-HV-19/0.18-(2). H-6JLD25150 H-6JLD27076 H-6ZCLD41060
W1001 ZC1002 ZC1003 ZC1004		

**PA UNIT (USA MODEL)**

**344A4573P3/JHM-471PAL 344A4573P4/JHM-471PBL**  
**344A4573P5/JHM-471PCL 344A4573P6/JHM-471PAH**  
**344A4573P7/JHM-471PBH 344A4573P8/JHM-471PCH**

SYMBOL	PART NO.	DESCRIPTION
A1001 A1001 A1001 A1001 A1001 A1001 A1002 A1002	Note: Parts listed are for reference only. Refer to Service Section for serviceable parts.	PA CIRCUIT CAH-545AL (Used in P3) PA CIRCUIT CAH-545BL (Used in P4) PA CIRCUIT CAH-545CL (Used in P5) PA CIRCUIT CAH-545AH (Used in P6) PA CIRCUIT CAH-545BH (Used in P7) PA CIRCUIT CAH-545CH (Used in P8) INTERFACE (Used in P3, P4, P5) INTERFACE (Used in P6, P7, P8) ----- CAPACITORS ----- Ceramic: 1000 pF +200%, -0%, 50 VDCW temp coef +20%,-55%. Ceramic: 1000 pF +200%, -0%, 50 VDCW temp coef +20%, -55%.( Used in P6, P7, P8 ) Ceramic: 1000pF +50 -20% 50 VDCW. ----- DIODE ----- Silicon fwd current 3A, 200 PIV ;sim to MOTOROLA MR751. (. Used in P3, P4, P5) ----- JACKS ----- Connector: TNC-R888. CCT9402-0501R. Connector And Wires (Used in P3, P4, P5) Connector And Wires (Used in P6, P7, P8) ----- WIRES ----- H-6ZCLD41060 H-6ZCLD40111 (Used in P6, P7, P8) H-6ZCLD40009 (Used in P3, P4, P5) ----- TERMINAL ----- ALB-01A (Used in P6, P7, P8)
C1001		
C1002		
C1004		
CD1001		
J1001 J1002 J1004 J1004		
ZC1002 ZC1003 ZC1003		
TB1001		

**POWER AMPLIFIER CIRCUIT (EUROPEAN)**  
**CAH-545E - 20 WATT**  
**CAH-545EA (Used in 344A4573P1)**  
**CAH-545EB (Used in 344A4573P2)**

SYMBOL	PART NO.	DESCRIPTION
C1 and C2 C3 C4 C5 C7 C8	Note: Parts listed are for reference only. Refer to Service Section for serviceable parts.	----- CAPACITORS ----- Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.  Electrolytic: 33 µF ±20% 25 VDCW, temp coef ±20%. Film: 0.1 µF ±10% 50 VDCW, temp coef ±15%. Ceramic: 4.7 µF 20% 35 VDCW, temp coef ±10%. Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM. Ceramic: 7 pF ±0.5 pF 50 VDCW, temp coef 0±30 PPM. (Used in P1). Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30 PPM. (Used in P2). Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in P1). Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in P2). Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM. Ceramic: 3 pF ±0.25pF 500 VDCW, temp coef 0±120 PPM.
C8		
C11		
C11		
C12 C13 and C14 C15		
C16 C17 C19 C20		
C21 C22 thru C24 C25 C26 C27 C28 C30 C31 C32 and C33 C34 C35 C36 C37 C38		
C39 and C40 C43 C44 C60 thru C62		
CD1 and CD2 CD3 and CD4 CD7 CD8 CD9		
CD13		
HC1 HC1		
IC1		
IC2		
J1 and J2 J3		

SYMBOL	PART NO.	DESCRIPTION
J4 L1 L2 L3 and L4 L5 thru L8 L9 and L10 L11	Note: Parts listed are for reference only. Refer to Service Section for serviceable parts.	Connector Coil: 0.22 uH. Coil: RF 0.22 uH. Coil: 19 nH.  RF Coil: AIRWOUND  Coil: RF 19 nH.  Coil: RF 0.22 uH. ----- RESISTORS ----- Metal film: 470 ohms ±5%, 100 VDCW 1/10W. Metal film: 12 ohms ±5%, 200 VDCW 1/4W. Metal film: 470 ohms ±5%, 100 VDCW 1/10W. Metal film: 22 ohms ±5%, 200 VDCW 1/2W.  Metal film: 100 ohms ±5%, 250 VDCW 1W. Metal film: 100 ohms ±5%, 100 VDCW 1/10W. Metal film: 47 ohms ±5%, 100 VDCW 1/10W.  Metal film: 47K ohms ±5%, 200 VDCW 1/8W. Metal film: 27K ohms ±5%, 100 VDCW 1/10W. Metal film: 2.7K ohms ±5%, 100 VDCW 1/10W. Metal film: 390 ohms ±5%, 200 VDCW 1/4W. Metal film: 470 ohms ±5%, 200 VDCW 1/4W. Metal film: 1K ohms ±5%, 100 VDCW 1/10W. Metal film: 2.2K ohms ±5%, 200 VDCW 1/10W.  Metal film: 100k ohms ±5%, 100 VDCW 1/10W. Metal film: 3.3K ohms ±5%, 100 VDCW 1/10W. Metal film: 4.7k ohms ±5%, 100 VDCW 1/10W. Metal film: 2.2K ohms ±5%, 100 VDCW 1/10W. Metal film: 47K ohms ±5%, 100 VDCW 1/10W. Metal film: 1K ohms ±5%, 100 VDCW 1/10W. Posistor: sim to MURATA PTH9M04BE222TSF333. Metal film: 100 ohms ±5%, 250 VDCW 1W. Metal film: 10K ohms ±5%, 100 VDCW 1/10W. Variable: 10K ohms ----- TRANSISTOR ----- Silicon, NPN: sim to PANASONIC 2SD1445A. Silicon, NPN: sim to NEC 2SD596-T1B DV3. Silicon, PNP: sim to PANASONIC 2SB953A. Silicon, NPN: sim to NEC 2SD596-T1B DV3. Silicon, PNP: sim to NEC 2SB624-T1B BV3. Silicon, NPN: sim to NEC 2SD596-T1B DV3. Silicon, PNP: sim to NEC 2SB624-T1B BV3.
R1 R2 R3 R4 and R5 R6 R8 R9 and R10 R11 R14 R15 R16 R17 R18 R19 thru R21 R22 R23 R24 R25 R26 R27 R28 R35 R36 RV1		
TR1 TR2 TR4 TR5 TR6 TR7 TR8		

**POWER AMPLIFIER CIRCUIT (USA)**

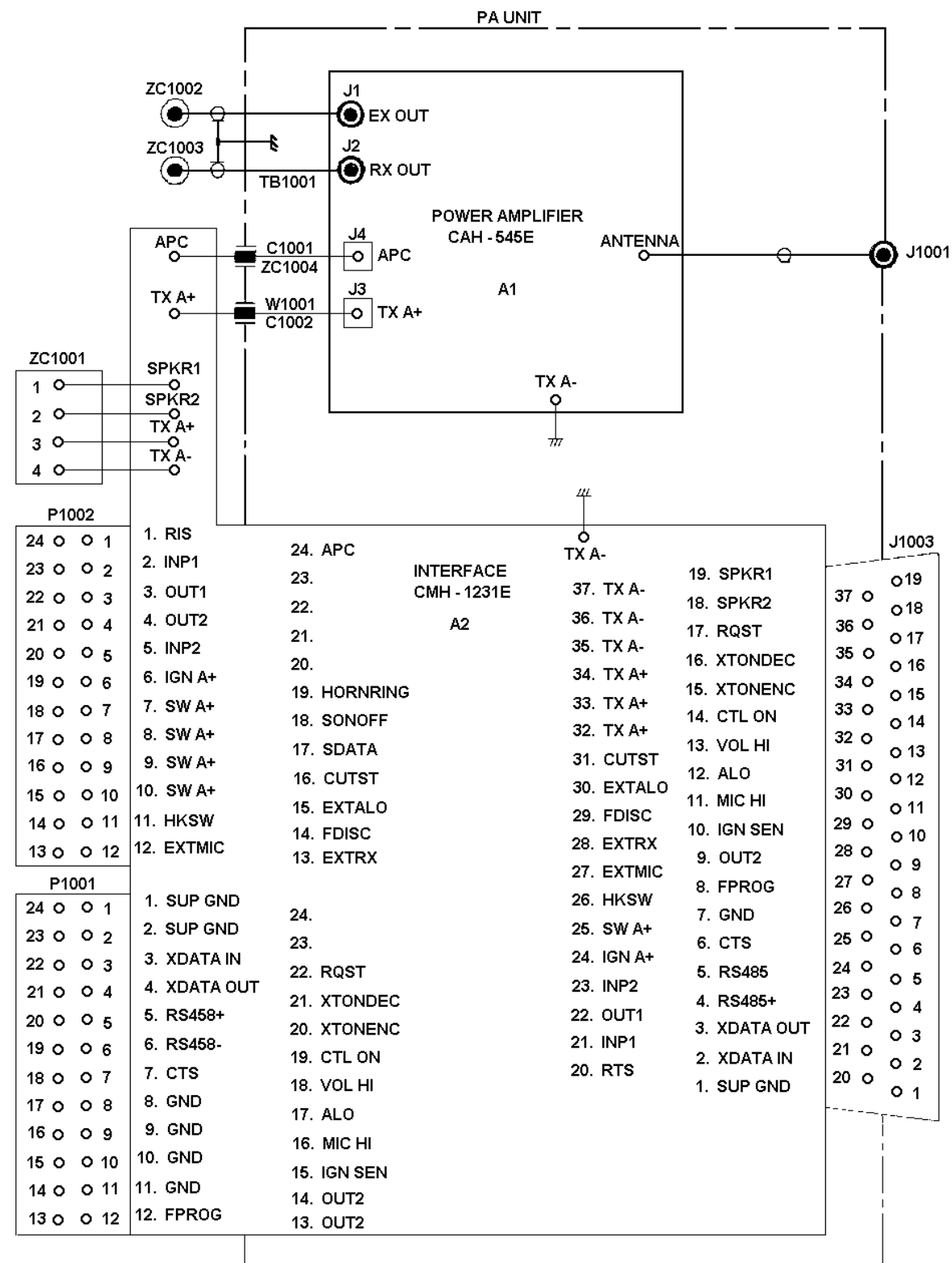
**CAH-545L - 35/40 WATT**  
**CAH-545H - 80/100 WATT**  
**CAH-545AL (Used in 344A4573P3), CAH-545BL (Used in 344A4573P4)**  
**CAH-545CL (Used in 344A4573P5), CAH-545AH (Used in 344A4573P6)**  
**CAH-545BH (Used in 344A4573P7), CAN-545CH (Used in 344A4573P8)**

SYMBOL	PART NO.	DESCRIPTION
C1 and C2 C3 C5 C6	Note: Parts listed are for reference only. Refer to Service Section for serviceable parts.	----- CAPACITORS ----- Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.  Electrolytic: 33 µF ±20% 25 VDCW, temp coef ±20%. Ceramic: 0.01 µF ±10% 50 VDCW, temp coef 0±10%. Ceramic: 0.1 µF +80%, -20% 50 VDCW, temp coef +30%, -80%. Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P3, P4, P6). Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P7, P8). Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P5). Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM. Ceramic: 56 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P3, P6).
C7 C7 C7 C8 C9		

SYMBOL	PART NO.	DESCRIPTION
C9	Note: Parts listed are for reference only. Refer to Service Section for serviceable parts.	Ceramic: 47 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P4, P5, P7, P8).
C10		Ceramic: 56 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P3, P6).
C10		Ceramic: 43 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P7).
C10		Ceramic: 36 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P5, P8).
C10		Ceramic: 47 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P4).
C11		Metal mica: 56 pF ±5% 100 VDCW.(Used in P6, P7).
C11		Metal mica: 36 pF ±5% 100 VDCW.(Used in P3).
C11		Metal mica: 33 pF ±5% 100 VDCW. (Used in P4, P5, P8).
C12		Metal mica: 39 pF ±5% 100 VDCW. (Used in P6).
C12		Metal mica: 47 pF ±5% 100 VDCW. (Used in P4, P5).
C12		Metal mica: 33 pF ±5% 100 VDCW. (Used in P7, P8).
C12		Metal mica: 51 pF ±5% 100 VDCW. (Used in P3).
C13		Mica: 30 pF ±5% 500 VDCW. (Used in P3, P6).
C13		Mica: 24 pF ±5% 500 VDCW. (Used in P7, P5).
C13		Mica: 27 pF ±5% 500 VDCW. (Used in P4).
C14		Mica: 90 pF ±5% 500 VDCW. (Used in P3, P4, P5).
C14		Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P6, P7, P8).
C15		Ceramic: 3 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM. (Used in P6).
C15		Ceramic: 5 pF ±0.25pF 500 VDCW, temp coef 0±60 PPM. (Used in P7).
C15		Ceramic: 4 pF ±0.25pF 500 VDCW, temp coef 0±60 PPM.(Used in P8).
C16		Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM.
C17		Electrolytic: 22 uF ±10% 40 VDCW. (Used in P6, P7, P8).
C18		Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P6).
C18		Ceramic: 9 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P7).
C18		Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P8).
C19		Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P6, P7, P8).
C20		Mica: 56 pF ±5% 500 VDCW. (Used in P6).
C20		Mica: 47 pF ±5% 500 VDCW. (Used in P7).
C20		Mica: 36 pF ±5% 500 VDCW. (Used in P8).
C21		Mica: 47 pF ±5% 500 VDCW. (Used in P6).
C21		Mica: 39 pF ±5% 500 VDCW. (Used in P7).
C21		Mica: 36 pF ±5% 500 VDCW. (Used in P8).
C22		Metal mica: 39 pF ±5% 100 VDCW. (Used in P6).
C22		Metal mica: 36 pF ±5% 100 VDCW. (Used in P7).
C22		Metal mica: 33 pF ±5% 100 VDCW. (Used in P8).
C23		Metal mica: 56 pF ±5% 100 VDCW. (Used in P6).
C23		Metal mica: 47 pF ±5% 100 VDCW. (Used in P7, P8).
C24		Metal mica: 30 pF ±5% 100 VDCW. (Used in P6).
C24		Metal mica: 24 pF ±5% 100 VDCW. (Used in P7).
C24		Metal mica: 18 pF ±5% 100 VDCW. (Used in P8).
C25		Mica: 90 pF ±5% 500 VDCW. (Used in P6, P7, P8).
C26		Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P6, P7).
C26		Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P8).
C27		Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P6).
C27		Ceramic: 9 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P7).
C27		Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM. (Used in P8).
C28		Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in P6, P7, P8).
C29		Mica: 47 pF ±5% 500 VDCW. (Used in P6).
C29		Mica: 39 pF ±5% 500 VDCW. (Used in P7).
C29		Mica: 36 pF ±5% 500 VDCW. (Used in P8).
C30		Mica: 56 pF ±5% 500 VDCW. (Used in P6).
C30		Mica: 47 pF ±5% 500 VDCW. (Used in P7).
C30		Mica: 36 pF ±5% 500 VDCW. (Used in P8).
C31		Metal mica: 56 pF ±5% 100 VDCW. (Used in P6).
C31		Metal mica: 47 pF ±5% 100 VDCW. (Used in P7, P8).
C32		Metal mica: 39 pF ±5% 100 VDCW. (Used in P6).
C32		Metal mica: 36 pF ±5% 100 VDCW. (Used in P7).
C32		Metal mica: 33 pF ±5% 100 VDCW. (Used in P8).
C33		Metal mica: 30 pF ±5% 100 VDCW. (Used in P6).
C33		Metal mica: 24 pF ±5% 100 VDCW. (Used in P7).
C33		Metal mica: 18 pF ±5% 100 VDCW. (Used in P8).

\*COMPONENTS, ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

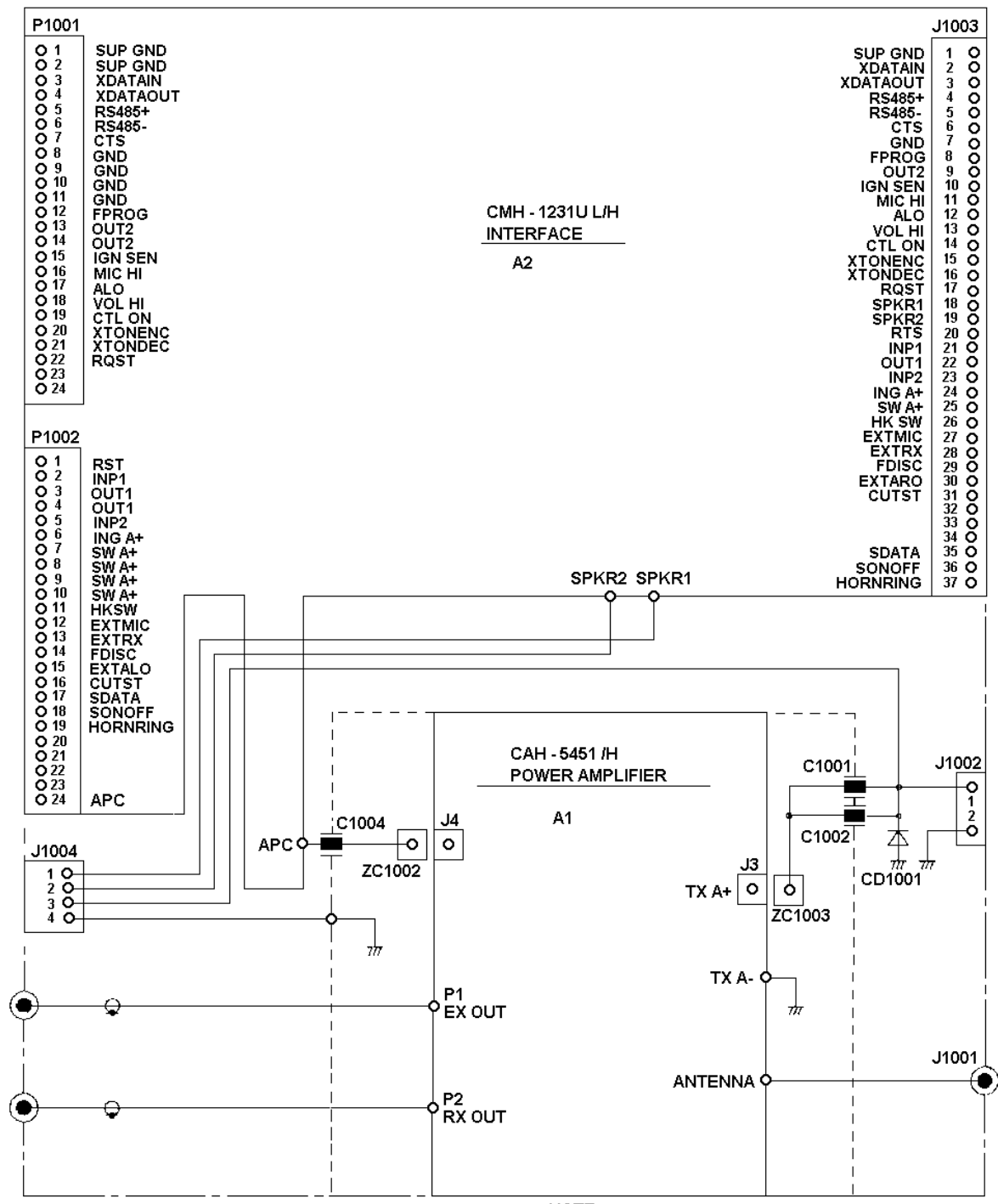




INTERCONNECTION DIAGRAM  
EUROPEAN UHF PA UNIT

(DD00-JHM-471PE)





NOTE  
 C1002: ONLY HIGH POWER UNIT  
 CD1001: ONLY LOW POWER UNIT

INTERCONNECTION DIAGRAM  
 U.S.A. UHF PA UNIT

(DD00-JHM-471PL/H)

COMPONENT IDENTIFICATION CHART 403-512  
MHz 35/40-Watt Power Amplifier

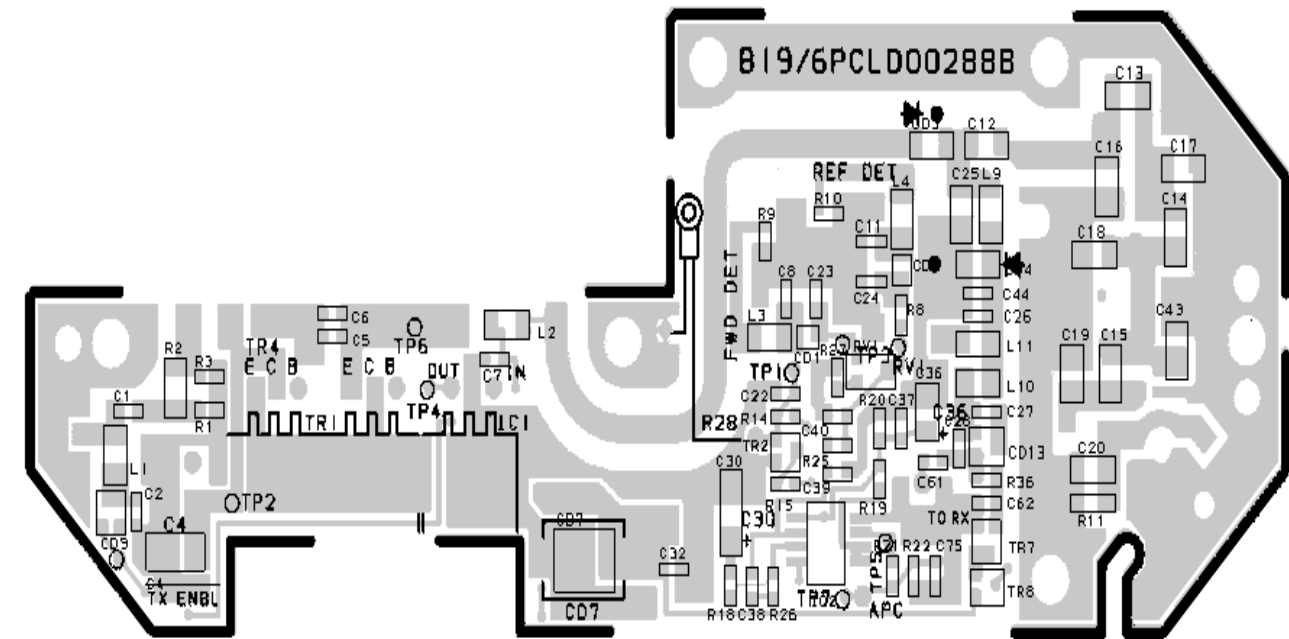
PART	CAH-545LA 403-440 MHz (40W)	CAH-545LB 440-512 MHz (40W)	CAH-545LC 470-512 MHz (35W)
C7	12 pF	10 pF	10 pF
C9	56 pF	47 pF	47 pF
C10	56 pF	47 pF	36 pF
C11	43 pF	33 pF	39 pF
C12	39 pF	36 pF	36 pF
C13	30 pF	27 pF	22 pF
C41	12 pF	12 pF	10 pF
C50	6 pF	6 pF	5 pF
C58	3 pF	2 pF	2 pF
C59	5 pF	4 pF	3 pF
C60	6 pF	6 pF	7 pF
C61	2 pF	1 pF	1 pF
C64	5 pF	4 pF	3 pF
C65	5 pF	4 pF	4 pF
C66	4 pF	4 pF	3 pF
C67	3pF	-	-
L2	6LALD20855	6LALD20850	6LALD20850
L6	6LALD20855	6LALD20850	6LALD20850

(MADE FROM DD00-CAH-545L 2/2)

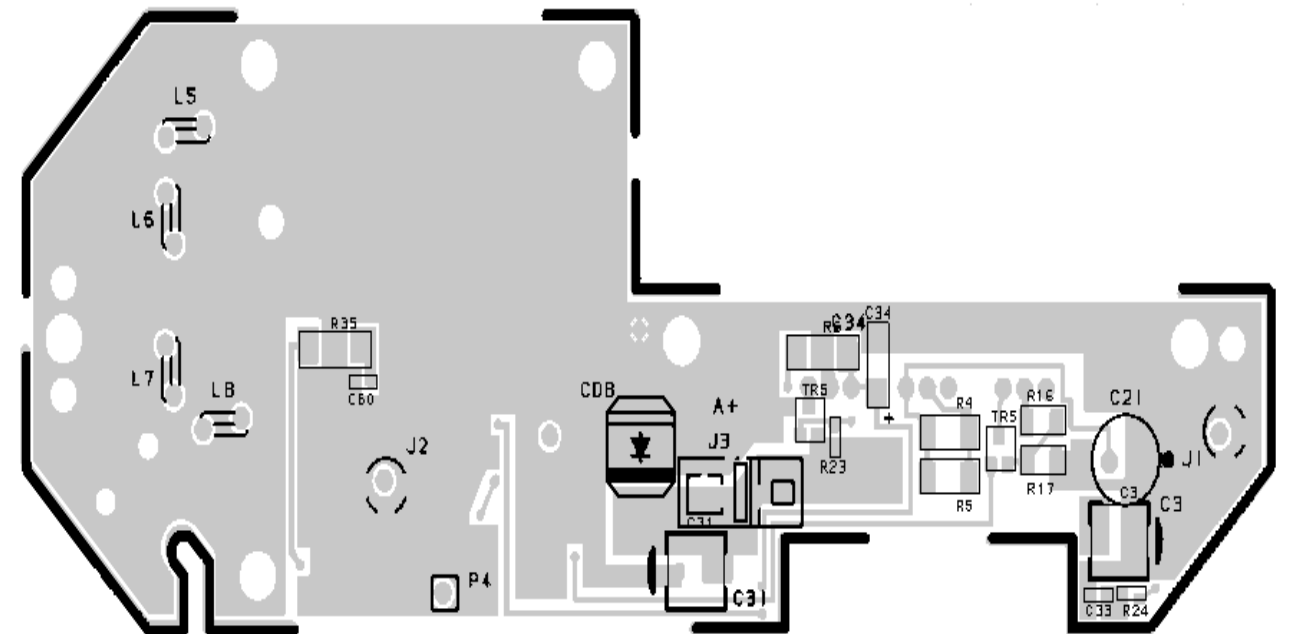
COMPONENT IDENTIFICATION CHART 403-512  
MHz 80/100-Watt Power Amplifier

PART	CAH-545HA 403-440 MHz (100W)	CAH-545HB 440-512 MHz (100W)	CAH-545HC 470-512 MHz (80W)
C7	12 pF	10 pF	10 pF
C9	56 pF	47 pF	47 pF
C10	56 pF	43 pF	36 pF
C11	43 pF	36 pF	33 pF
C12	43 pF	43 pF	33 pF
C13	30 pF	24 pF	-
C15	5 pF	5 pF	4 pF
C18	10 pF	9 pF	8 pF
C20	56 pF	47 pF	36 pF
C21	47 pF	39 pF	36 pF
C22	43 pF	36 pF	36 pF
C23	43 pF	43 pF	33 pF
C24	30 pF	27 pF	24 pF
C26	10 pF	10 pF	8 pF
C27	10 pF	9 pF	8 pF
C29	47 pF	39 pF	36 pF
C30	56 pF	47 pF	36 pF
C31	43 pF	43 pF	33 pF
C32	43 pF	36 pF	36 pF
C33	30 pF	27 pF	24 pF
C35	10 pF	10 pF	8 pF
C41	6 pF	8 pF	6 pF
C44	6 pF	5 pF	5 pF
C45	6 pF	5 pF	5 pF
C49	8 pF	7 pF	-
C50	-	-	4 pF
C56	3 pF	3 pF	4 pF
C57	7 pF	5 pF	6 pF
C58	3 pF	3 pF	2 pF
C59	3 pF	3 pF	2 pF
C60	3 pF	3 pF	4 pF
C61	2 pF	2 pF	1 pF
C62	7 pF	6 pF	6 pF
C63	4 pF	4 pF	3 pF
C64	3 pF	2 pF	1.5 pF
C65	6 pF	6 pF	4 pF
C66	-	7 pF	5 pF
C97	-	-	22 pF
R14	12kΩ	18kΩ	33kΩ
R16	3.9kΩ	3.9kΩ	4.7kΩ
R36	3.3kΩ	1.8kΩ	1.8kΩ
L2	6LALD20855	6LALD20855	6LALD20855
L23	6LALD12014	6LALD12014	6LALD12013
L24	6LALD12014	6LALD12014	6LALD12013
HC1	M57704M-38	M57704H-38	M57704SH-38

(MADE FROM DD00-CAH-545H 2/2)

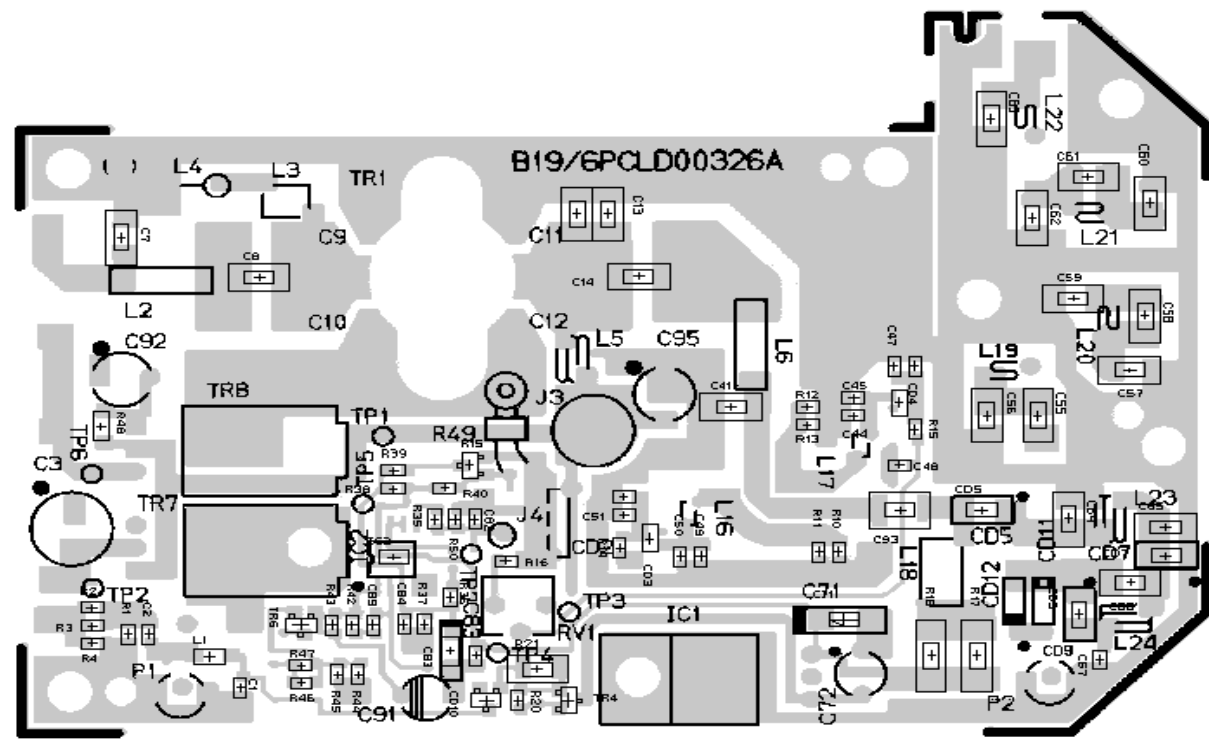


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(B19/6PCLD00288B, Chip Components)  
(B19/6PCLD00288B, Component Side)

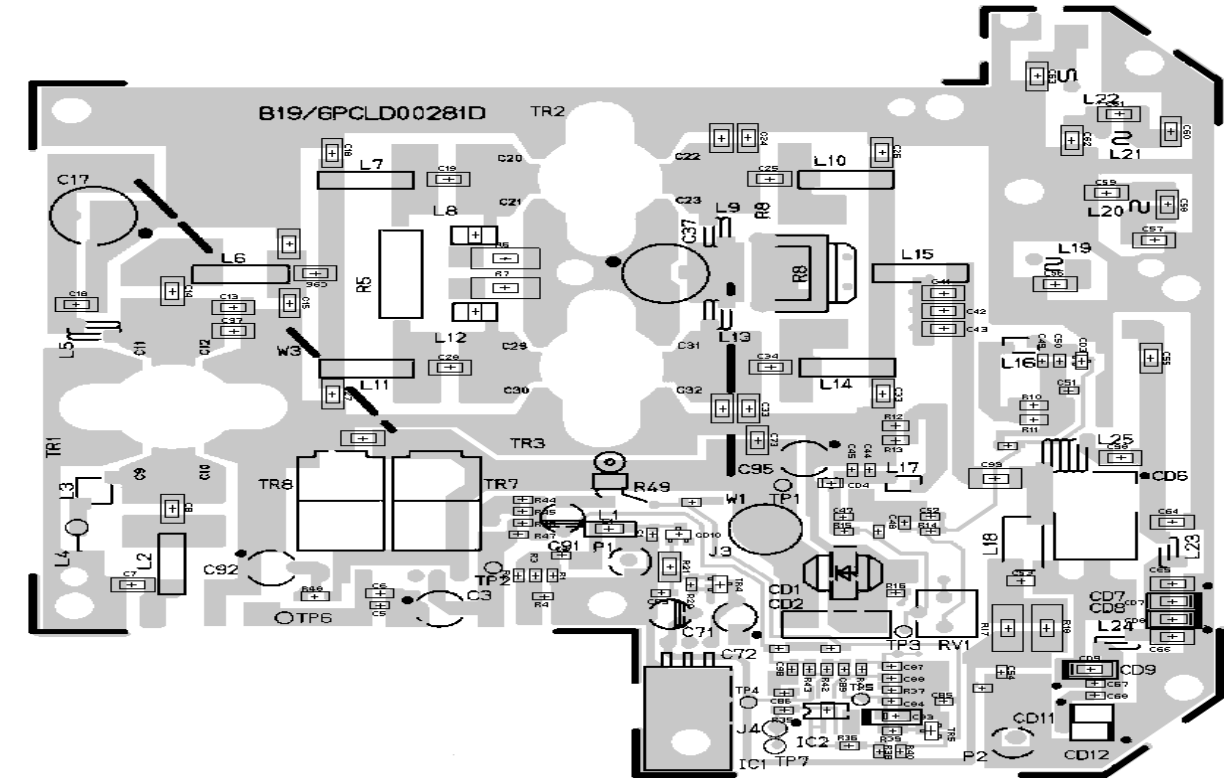


(B19/6PCLD00288B, Chip Components)  
(B19/6PCLD00288B, Solder Side)

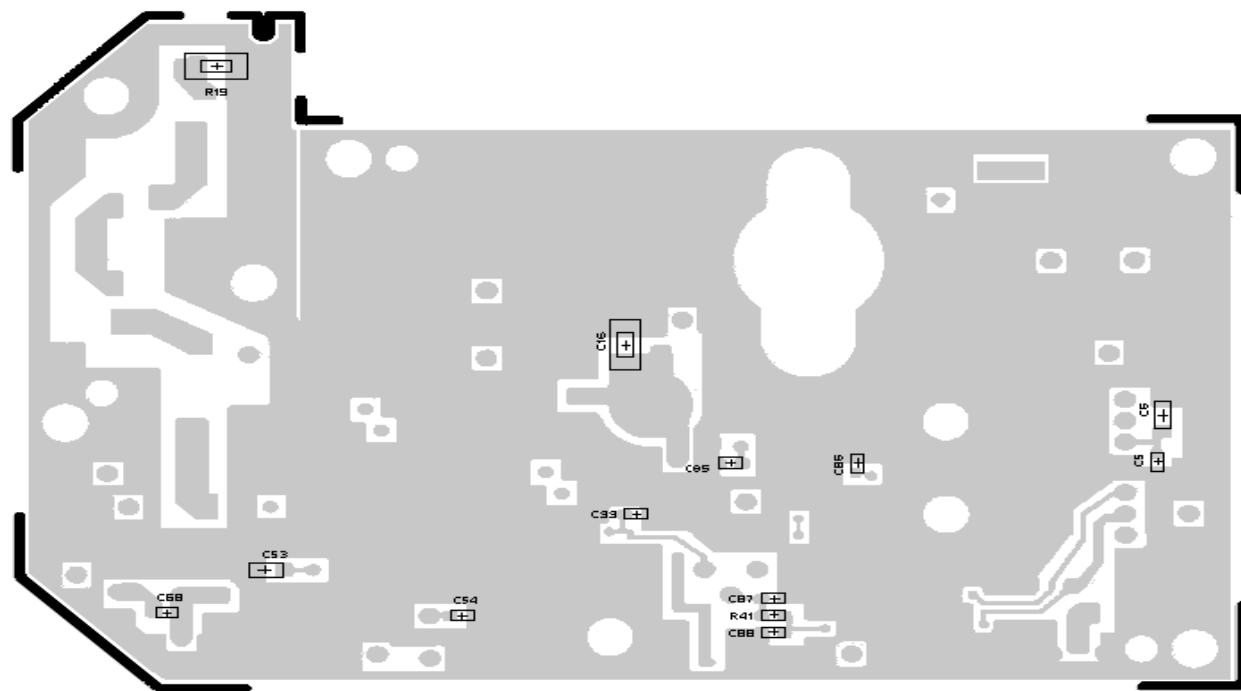
20-Watt Power Amplifier  
CAH-545E



(19B/6PCLD00326A, Component Side Layout)  
 (19B6PCID00326A, Chip Components)  
 (19B6PLCD00326A, Component Side)

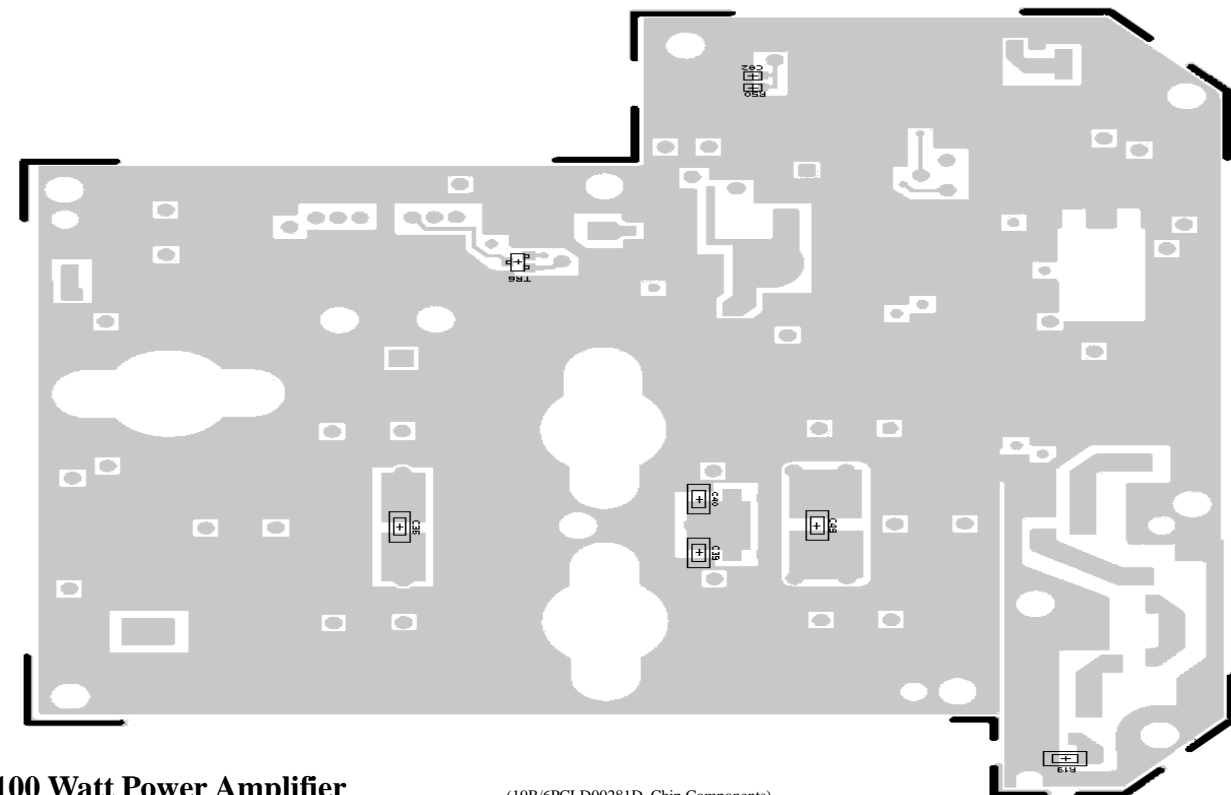


(19B/6PCLD00281D, Component Side Layout)  
 (19B/6PCLD00281D, Chip Components)  
 (19B/6PCLD00281D, Component Side)



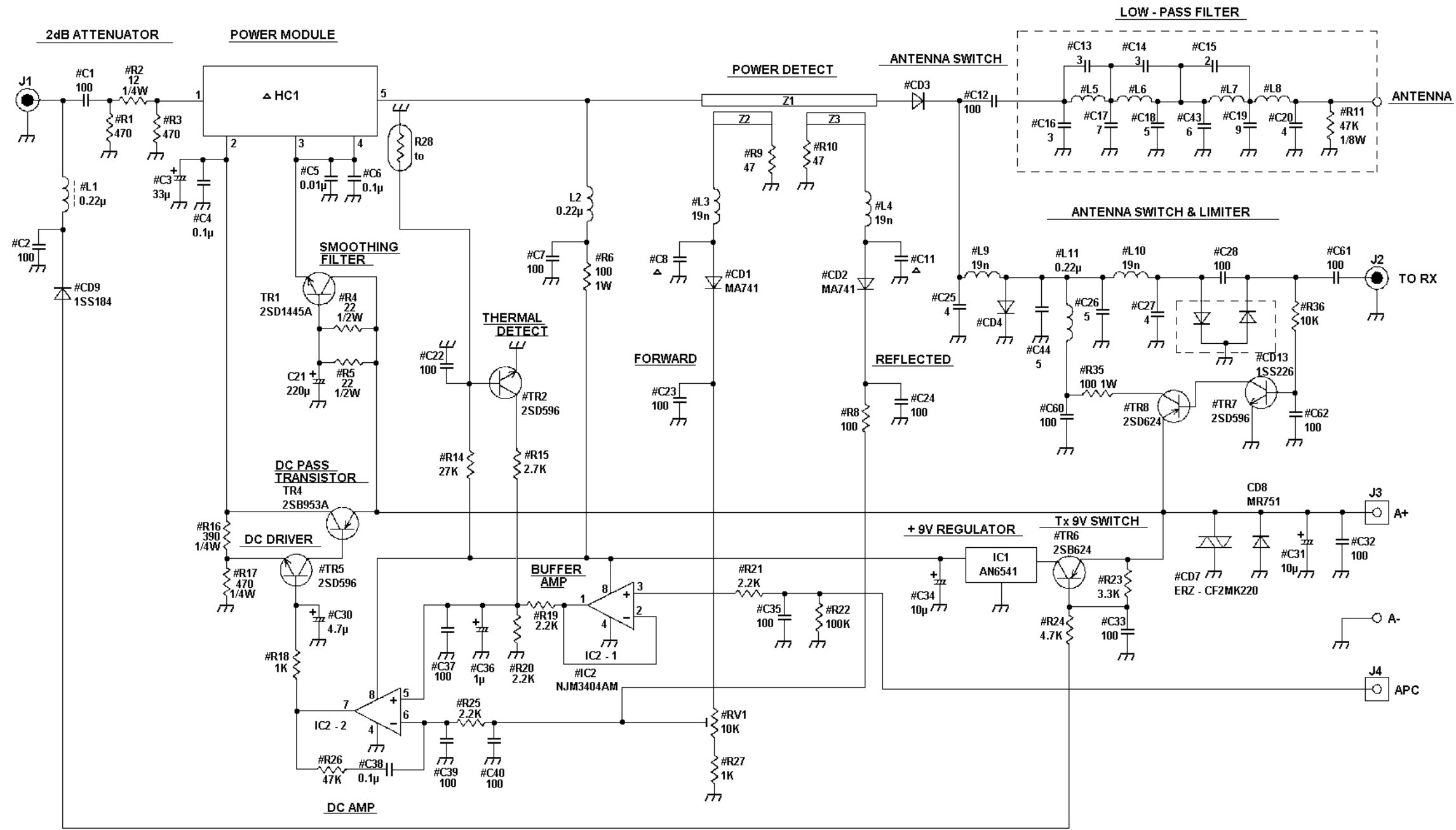
(19B/6PCLD00326A, Component Side Layout)  
 (19B/6PCLD0032A, Chip Components)  
 (19B/6PCLD00326A, Solder Side)

**35/40 Watt Power Amplifier**  
 CAH-545L



(19B/6PCLD00281D, Chip Components)  
 (19B/6PCLD00281D, Solder Side)

**80/100 Watt Power Amplifier**  
 CAH-545H



NOTES:

1. "#" IDENTIFIES CHIP COMPONENTS (EXAMPLE #R12 OR R12#) WHICH ARE LOCATED ON THE COMPONENT SIDE OF THE BOARD.
2. Z1, Z2 AND Z3 ARE STRIPLINE PART OF PWB.
3. RV1 IS FACTORY TUNED AND DOES NOT REQUIRE FURTHER ADJUSTMENT.

ALL RESISTORS ARE 1/10 OR 1/8 WATT UNLESS OTHERWISE SPECIFIED.  
RESISTOR VALUES IN Ω UNLESS FOLLOWED BY MULTIPLIER K OR M.  
CAPACITOR VALUES IN P UNLESS FOLLOWED BY MULTIPLIER μ.  
INDUCTANCE VALUES IN H UNLESS FOLLOWED BY MULTIPLIER m OR μ.

DC VOLTAGE READINGS

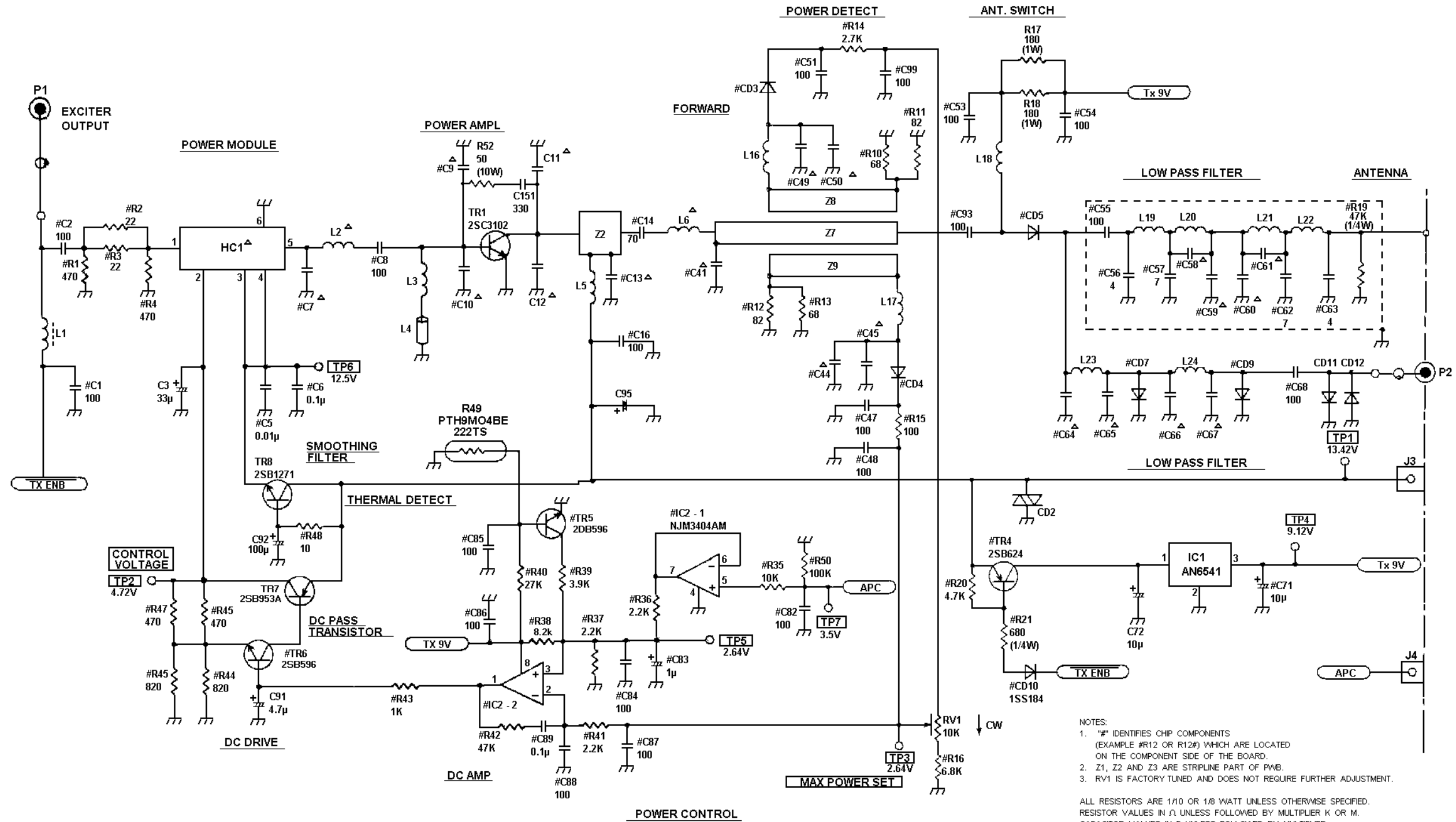
ALL VOLTAGES ARE TYPICAL. VOLTAGES ARE MEASURED WITH A 10Meg OHM PER VOLT METER. REFERENCE TO GROUND. VOLTAGE READINGS ARE TAKEN WITH THE TRANSMITTER UNKEYED/KEYED. EX .45 (UNKEYED)/.05 (KEYED).

COMPONENT IDENTIFICATION CHART

PART	SPLIT	378 - 415 (MHz)	403 - 440 (MHz)	440 - 470 (MHz)
C8			7pF	6pF
C11			7pF	6pF
HC1		M57788SL - 38	M57788SL - 38	M57788H - 38

20 Watt Power Amplifier  
CAH-545E

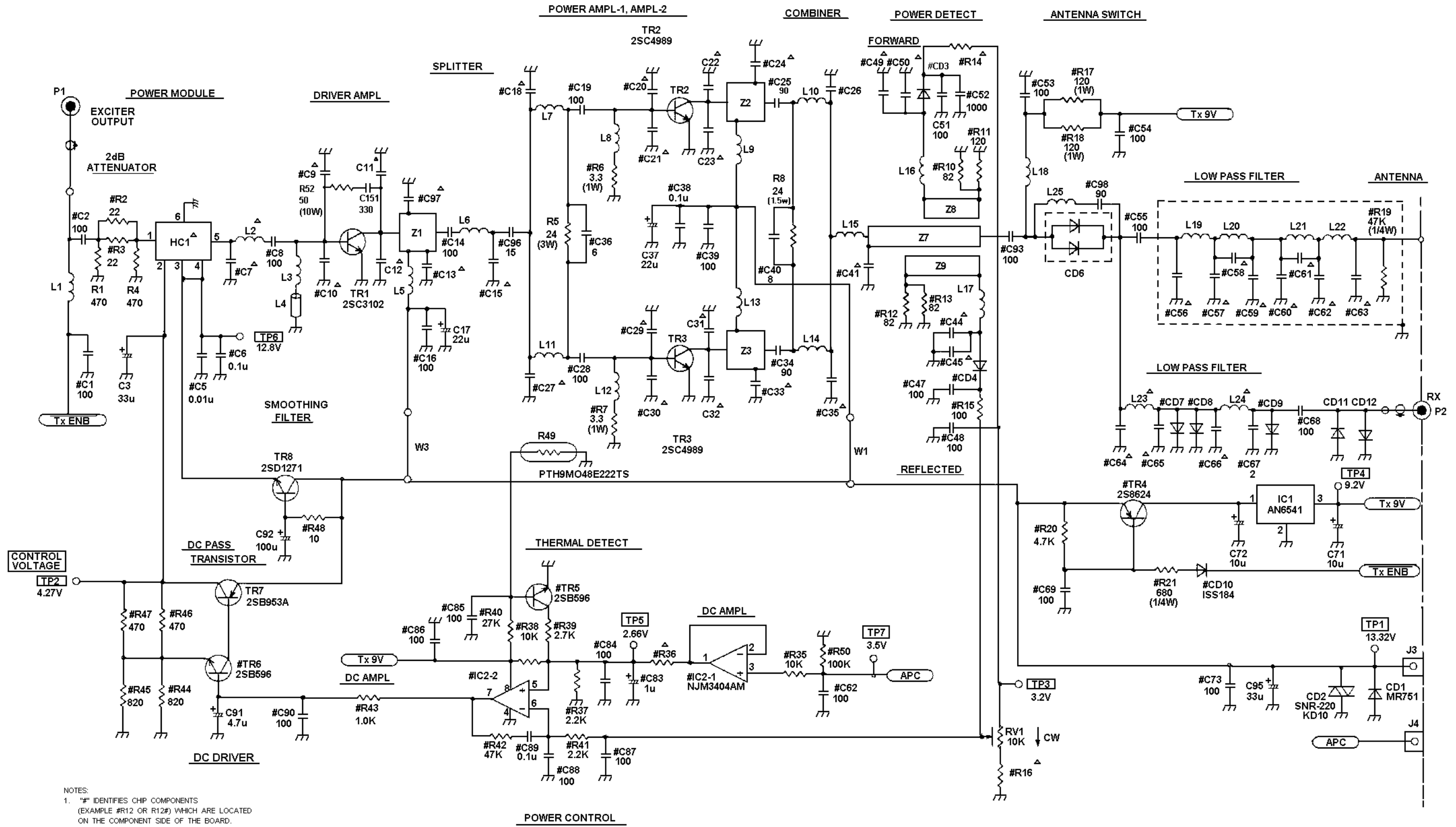
(DD00-CAH-545E)



NOTES:  
 1. "#" IDENTIFIES CHIP COMPONENTS (EXAMPLE #R12 OR R12#) WHICH ARE LOCATED ON THE COMPONENT SIDE OF THE BOARD.  
 2. Z1, Z2 AND Z3 ARE STRIPLINE PART OF PWB.  
 3. RV1 IS FACTORY TUNED AND DOES NOT REQUIRE FURTHER ADJUSTMENT.  
 ALL RESISTORS ARE 1/10 OR 1/8 WATT UNLESS OTHERWISE SPECIFIED. RESISTOR VALUES IN Ω UNLESS FOLLOWED BY MULTIPLIER K OR M. CAPACITOR VALUES IN P UNLESS FOLLOWED BY MULTIPLIER μ. INDUCTANCE VALUES IN H UNLESS FOLLOWED BY MULTIPLIER m OR μ.

35/40 Watt Power Amplifier  
 CAH-545L

(DD00-CAH-545L 1/2)



NOTES:  
 1. "N" IDENTIFIES CHIP COMPONENTS (EXAMPLE #R12 OR R12#) WHICH ARE LOCATED ON THE COMPONENT SIDE OF THE BOARD.  
 2. Z1, Z2 AND Z3 ARE STRIPLINE PART OF PWB.  
 3. RV1 IS FACTORY TUNED AND DOES NOT REQUIRE FURTHER ADJUSTMENT.

ALL RESISTORS ARE 1/10 OR 1/8 WATT UNLESS OTHERWISE SPECIFIED.  
 RESISTOR VALUES IN Ω UNLESS FOLLOWED BY MULTIPLIER K OR M.  
 CAPACITOR VALUES IN P UNLESS FOLLOWED BY MULTIPLIER μ.  
 INDUCTANCE VALUES IN H UNLESS FOLLOWED BY MULTIPLIER m OR μ.

80/100 Watt Power Amplifier  
 CAH-545H

(DD00-CAH-545H 1/2)